The Temple Materials Institute (TMI) housed in the College of Science and Technology is proud to announce the Materials Science and Engineering Fellowship. This fellowship will engage students in research projects spanning materials chemistry, physics and engineering in a 10-week residential experience beginning Tuesday, May 30, 2017 and ending Friday, August 11, 2017. Participating fellows will receive a $4500 stipend, on-campus housing, and a travel allowance. This program aims to support historically underserved students with limited opportunities. In order to be eligible for the program applicants must be a rising junior or senior, be enrolled in a traditional science major, and have a minimum overall GPA of 2.85.

Application Deadline is April 14, 2017

For more information please contact:

Susan Jansen Varnum, Ph.D
Associate Dean for Science Education
Professor of Chemistry
Email: susan.varnum@temple.edu

Kenneth Ruff, M.Ed.
Assistant Professor
Email: kruff@temple.edu

How to apply:

A complete application package includes:

- A Statement of Interest (500 words or less)
- 2 Letters of recommendation
- A resume
- A copy of current official or unofficial transcript

Submit a completed application package via fax to 215-204-2654 or via mail to:

Temple University, CST Office of the Dean
1115 W. Polett Walk
Gladfelter Hall, Room 628 (025-29)
Philadelphia, PA 19122
Attn: TMI Fellowship